Unit: mm

7.0±0.4

06+03

11-5H1

4.4土0.25

0.4±0.1

2.54±0.25

JEDEC

TOSHIBA

Weight: 0.1 g (typ.)

JEITA

TOSHIBA PHOTOCOUPLER PHOTO RELAY

TLP3114

MEASUREMENT INSTRUMENTS LOGIC IC TESTERS / MEMORY TESTERS **BOARD TESTERS / SCANNERS**

The TOSHIBA TLP3114 Mini-flat photorelay is a small-outline photorelay, suitable for surface-mount assembly. The TLP3114 consists of a GaAs infrared-emitting diode optically coupled to a photo-MOS FET and housed in a 4-pin package.

Its characteristics include low OFF-state current and low output pin capacitance, enabling it to be used in high-frequency measuring instruments.

Features

- 4 pin SOP (2.54SOP4)
- 1-Form-A

1 **C**

2 **C**

- : 40 V (min) Peak Off-State Voltage
 - Trigger LED Current
- **On-State Current**
- **On-State Resistance**
- **Output** Capacitance
- Isolation Voltage

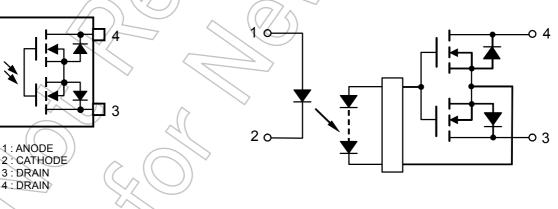
- : 2.1 mm high, 2.54 mm pitch
- : 4 mA (max) : 250 mA (max) $: 3 \Omega$ (max), 2Ω (typ.)
- : 7 pF (max), 5 pF (typ.)
- : 1500 Vrms (min)



1 : ANODE

3 DRAIN 4 : DRAIN





Absolute Maximum Ratings (Ta = 25°C)

	CHARACTERISTIC	SYMBOL	RATING	UNIT	
	Forward Current	١ _F	50	mA	
Ω	Forward Current Derating (Ta ≥ 25°C)	∆l _F /°C	-0.5	mA/°C	
Ш	Reverse Voltage	V _R	5	V	
	Junction Temperature	Tj	125	°C	
DETECTOR	Off-State Output Terminal Voltage	V _{OFF}	40	V	
	On-State Current	I _{ON}	250	mA	
	On-State Current Derating (Ta ≥ 25°C)	∆l _{ON} /°C	-2.5	mA/°C	
	Junction Temperature	Tj	125	°C)
Storage Temperature Range		T _{stg}	-40 to 125	°C	
Operating Temperature Range		T _{opr}	-20 to 85	. °0	
Lead	Soldering Temperature (10 s)	T _{sol}	260	°C	
Isolat	tion Voltage (AC, 1 minute, $R.H. \le 60\%$) (Note 1)	BVS	1500	Vrms	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

(Note 1):Device considered a two-terminal device : Pins 1 and 2 shorted together, and pins 3 and 4 shorted together.

CAUTION

This device is sensitive to electrostatic discharge. When using this device, please ensure that all tools and equipment are earthed.

Recommended Operating Conditions

CHARACTERISTIC	SYMBOL	MIN	TYP.	MAX	UNIT
Supply Voltage	V _{DD}	77	_	32	V
Forward Current		(10)	_	30	mA
On-State Current	ION			250	mA
Operating Temperature	Topr	25	_	60	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Individual Electrical Characteristics (Ta = 25°C)

<u> </u>	CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
	Forward Voltage	VF	I _F = 10 mA	1.0	1.15	1.3	V
LED	Reverse Current	I _R	$V_R = 5 V$	_	—	10	μA
	Capacitance	CT	V = 0, f = 1 MHz		15		pF
DETECTOR	Off-State Current	IOFF	V _{OFF} = 30 V, Ta = 50°C		—	1000	pА
	Capacitance	C _{OFF}	V = 0, f = 100 MHz, t < 1 s		5	7	pF

Coupled Electrical Characteristics (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Trigger LED Current	I _{FT}	I _{ON} = 100 mA	—	_	4	mA
Return LED Current	I _{FC}	I _{OFF} = 10 μA	0.2	0.75	_	mA
On-State Resistance	R _{ON}	I _{ON} = 250 mA, I _F = 5 mA, t < 1 s	4	2	3	Ω

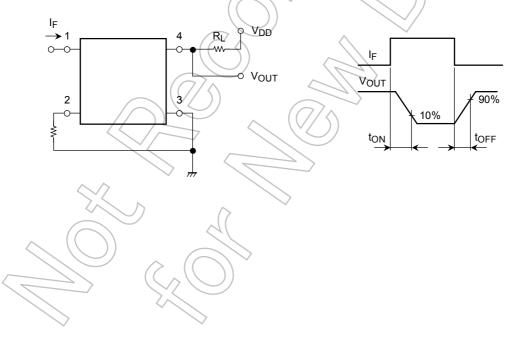
Isolation Characteristics (Ta = 25°C)

SYMBOL	TEST CONDITION		TYP.	MAX	UNIT
CS	V _S = 0 V, f = 1 MHz		0.8	—	pF
R _S	V _S = 500 V, R.H. ≤ 60%	5 × 10 ¹⁰	10 ¹⁴	_	Ω
	AC, 1 minute	1500	-6	/	Vrms
BVS	AC, 1 second (in oil)	_	3000	\searrow	viins
	DC, 1 minute (in oil)	_	3000	$\geq -$	Vdc
	C _S R _S	$\begin{array}{c c} C_{S} & V_{S} = 0 \ V, \ f = 1 \ \text{MHz} \\ \hline R_{S} & V_{S} = 500 \ V, \ \text{R.H.} \leq 60\% \\ \hline AC, \ 1 \ \text{minute} \\ \hline BV_{S} & AC, \ 1 \ \text{second (in oil)} \end{array}$	$\begin{tabular}{ c c c c c } \hline C_S & V_S = 0 \ V, \ f = 1 \ MHz & - \\ \hline R_S & V_S = 500 \ V, \ R.H. \le 60\% & 5 \times 10^{10} \\ \hline & & \\ \hline & & \\ \hline & & \\ BV_S & AC, \ 1 \ \text{minute} & 1500 \\ \hline & & \\ \hline & & \\ AC, \ 1 \ \text{second (in oil)} & - \\ \hline & & \\ \hline \hline & & \\ \hline & & \\ \hline & & \\ \hline \hline \hline \\ \hline \hline & & \\ \hline \hline \hline \\ \hline \hline \hline \\ \hline \hline \hline \hline$	$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	$ \begin{array}{c c c c c c c c c c c c c c c c c c c $

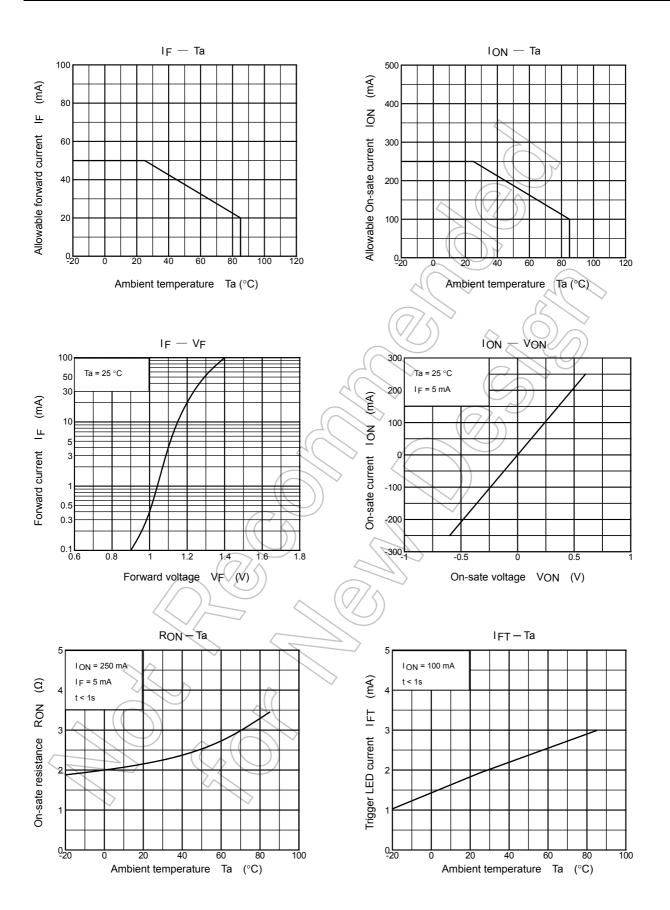
Switching Characteristics (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Turn-on Time		$R_{L} = 200 \Omega$ (Note 2)	\mathbb{Z}^{+}		500	
Turn-off Time	tOFF	$V_{DD} = 10 \text{ V}, \text{ I}_{\text{F}} = 10 \text{ mA}$)		500	μs

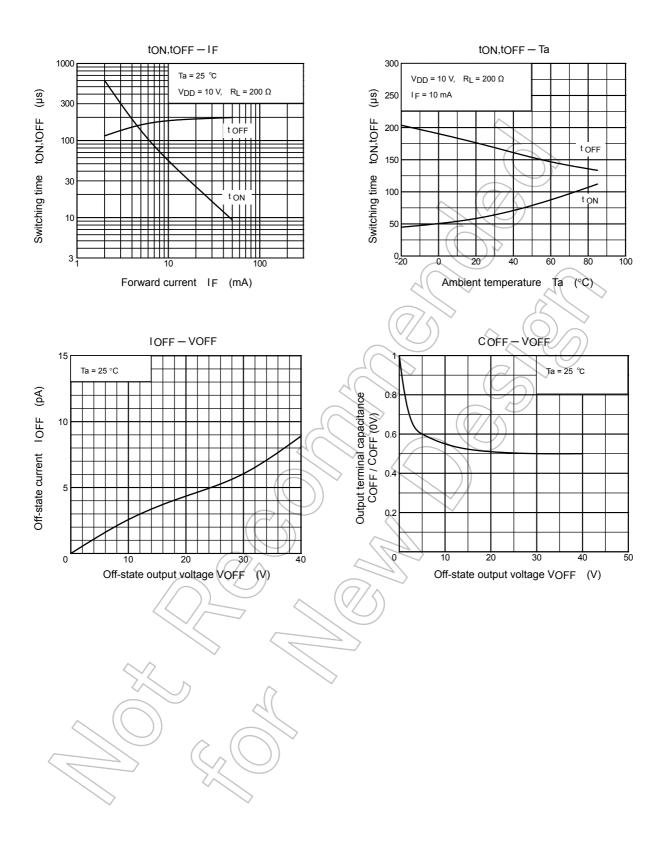
(Note 2) : SWITCHING TIME TEST CIRCUIT



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